

0020-4834P Attorney Docket No.

BIRCH, STEWART, KOLASCH & BIRCH, LLP

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COMBINED DECLARATION AND POWER OF ATTORNEY FOR PATENT AND DESIGN APPLICATIONS

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated next to my name; that I verily believe that I am the original, first and sole inventor (if only one inventor is named below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: POLYTETRAFLUOROETHYLENE BLOCK-SHAPED MOLDED ARTICLE

Insert Title:	A1	ID METHO	OD OF PRODUC	CING THE	E SAME		
Fill in Appropriate Information - For Use Without Specification Attached:	the specification w United States App and amended on _ the specification w International Appl	as filed on ication Number as filed on ication Numbe	September or PCT/JP99/(or September	7, 1999 04832)	(if applicable	_ as PCT
	I hereby state that amended by any amended by any amended I acknowledge the Regulations, §1.56. I do not know and thereof, or patented or year prior to this application date of this application representative or assign patent or inventor's certapplication by me or my I hereby claim fore or inventor's certificate!	I have reviewed ment referred a duty to disclude to disclude to disclude the described in a return the interest on this legal representing priority be sited below an interest and the site and th	ed and understand the c to above. ose information which	ontents of the a is material to p or or used in the n any country k use or on sale ted or made the ed States of A hs for designs) in any country t as follows. hited States Cool	bove-identified specifications and additional specification and the united States of American the United States of a subject of an inventor merica on an application of foreign to this application foreign to the United States of the United S	ation, including in Title 37, Codica before my or ition thereof or my America more to sertificate issue on filed by men, and that no a states of America reign applications	the claims, as de of Federal our invention more than one than one year led before the or my legal pplication for a prior to this
	Prior Foreign Applica					Priority C	Claimed
Insert Priority Information: (if appropriate)	264681/1998 (Number)	Japar (Country)	1	Sep. (Month/Da	18, 1998 ay/Year Filed)	₹ Yes	□ No
·	(Number)	(Country)		(Month/Da	ay/Year Filed)	☐ Yes	□ No
	(Number)	(Country)		(Month/Da	ay/Year Filed)	□ Yes	□ No
	(Number)	(Country)		(Month/Da	ay/Year Filed)	□ Yes	□ No
	I hereby claim the benef	t under Title 3	5, United States Code, §1	19(e) of any Un	ited States provisional a	pplications(s) lis	sted below.
Insert Provisional Application(s): (if any)	(Application Number)			(Filing	Date)		
	(Application Number) (Filing Date)						
	All Foreign Applications, if any, for any Patent or Inventor's Certificate Filed More than 12 Months (6 Months for Designs) Prior to the Filing Date of This Application:						
Insert Requested	Country		Application Number		Date of Filing (Month	/Day/Year)	
Information: (if appropriate)							
	I hereby claim the benefit under Title 35, United States Code, §120 of any United States and/or PCT application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States and/or PCT application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information which is material to the patentability as defined in Title 37, Code of Federal Regulations. §1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.						
Insert Prior U.S. Application(s): (if any)	(Application Number)		(Filing Date)		(Status - patented, per	nding, abandone	d)
Page I of 2	(Application Number)		(Filing Date)		(Status - patented, per	nding, abandone	d)

I hereby appoint the following attorneys to prosecute this application and/or an international application based on this application and to transact all business in the Patent and Trademark Office connected therewith and in connection with the resulting patent based on instructions received from the entity who first sent the application papers to the attorneys identified below, unless the inventor(s) or assignee provides said attorneys with a written notice to the contrary:

Raymond C. Stewart	(Reg. No. 21,066)	Terrell C. Birch	(Reg. No. 19,382)
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full Name of First or Sole Inventor: Insert Name of Inventor Insert Date This Document is Signed	GIVEN NAME/FAMILY NAME	INVENTOR'S SIGNATURE		DATE*			
Insert Date This Document is Signed	Kazuo ISHIWARI	HAZUO IShiwar	i	Mar. 8. 2001			
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Full Name of Second	GIVEN NAME/FAMILY NAME	INVENTOR'S SIGNATURE	300 000	DATE*			
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Full Name of Third Inventor, if any:	GIVEN NAME/FAMILY NAME	INVENTOR'S SIGNATURE		DATE*			
	GIVEN NAME/FAMILY NAME <u>Masahiko</u> <u>YAMADA</u>	inventor's signature Masahiko Yamada		DATE* Mar. 8. 2001			
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*DATE OF SIGNATURE